NSN 5962-00-739-5901

Memory Microcircuit - Page 1 of 1



View Online at https://aerobasegroup.com/nsn/5962-00-739-5901
Body Length:
Between 0.770 inches and 0.790 inches
Body Width:
Between 0.375 inches and 0.385 inches
Body Height:
Between 0.052 inches and 0.062 inches
Maximum Power Dissipation Rating:
625.0 milliwatts
Operating Tempurature Range:
-55.0/+125.0 degrees celsius
Storage Tempurature Range:
-65.0/+150.0 degrees celsius
Features Provided:
Hermetically sealed and monolithic and positive outputs and w/enable and programmable and programmed and w/decoded output
Inclosure Material:
Ceramic and glass
Inclosure Configuration:
Flat pack
Output Logic Form:
Transistor-transistor logic
Input Circuit Pattern:
18 input
Terminal Surface Treatment:
Solder
Voltage Rating And Type Per Characteristic:
-1.5 volts power source and 5.5 volts power source
Time Rating Per Chacteristic:
60.00 nanoseconds propagation delay time, low to high level output and 60.00 nanoseconds propagation delay time, high to low level
output
Memory Device Type:
Rom
Test Data Document:
$06840-6088465 \ drawing, \ this is the \ basic governing \ drawing, \ such as a \ contractor \ drawing, \ original \ equipment \ manufacturer \ drawing, \ etc.;$
excludes any specification, standard or other document that may be referenced in a basic governing drawing)
Terminal Type And Quantity:
28 flat leads
Shelf Life:
N/a
Unit Of Measure:
Demilitarization:

Fiig: A458a0

Yes - demil/mli